

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4313187

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	SHIN KOBAYASHI	02/03/2017
RECEIVING PARTY DATA		
Name:	ENPLAS CORPORATION	
Street Address:	30-1, NAMIKI 2-CHOME,	
City:	KAWAGUCHI-SHI, SAITAMA	
State/Country:	JAPAN	
Postal Code:	332-0034	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	15506540
CORRESPONDENCE DATA		
Fax Number:	(202)434-1501	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	202-434-1500	
Email:	wmulhall@s-n-h.com	
Correspondent Name:	STAAS & HALSEY LLP	
Address Line 1:	1201 NEW YORK AVENUE, N.W.	
Address Line 2:	SUITE 700	
Address Line 4:	WASHINGTON, D.C. 20005	
ATTORNEY DOCKET NUMBER:	1509.1101	
NAME OF SUBMITTER:	PAUL I. KRAVETZ	
SIGNATURE:	/Paul I. Kravetz/	
DATE SIGNED:	03/10/2017	
Total Attachments: 1		
source=Assignment#page1.tif		

U.S. ASSIGNMENT

SAW 130

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

(Insert Name(s) & Address(es) of ASSIGNEE(S))

ENPLAS CORPORATION of 30-1, Namiki 2-chome, Kawaguchi-shi, Saitama 332-0034 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled
(Title of Invention)

SOCKET FOR ELECTRIC COMPONENT

relating to International Patent Application PCT/JP2015/074156 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on :

(Insert date of execution of application, if not concurrent)

(b) filed on :

Serial No.:

Any registered attorney of STAAS & HALSEY LLP, 1201 New York Avenue, N.W., Suite 700 Washington, D.C. 20005 (202/434-1500) is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Typed Name & Signature of Inventor(s))

(Date)

(Typed Name & Signature of Witness(es))

1) <u>小林 博</u> KOBAYASHI, Shin	<u>2/3/2017</u>	<u>Toshimasa Uehara</u> UEHARA, Toshimasa
2) _____	_____	_____
3) _____	_____	_____
4) _____	_____	_____
5) _____	_____	_____
6) _____	_____	_____
7) _____	_____	_____